KMY

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# Specification

(Reference)

Title: FIXED THICK FILM CHIP RESISTORS;

**RECTANGULAR TYPE & PRECISION** 

Style: RGC1/32,1/20,1/16S,1/16,1/10,1/8

**RoHS COMPLIANCE ITEM** 

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Issue Dept.: Research & Development Department Hokkaido Research Center

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#### 1. Scope

1.1 This specification covers the detail requirements for fixed thick film chip resistors; rectangular type & precision, style of RGC1/32,1/20,1/16S,1/16,1/10,1/8.

## 1.2 Applicable documents

JIS C 5201-1: 1998, JIS C 5201-8: 1998, JIS C 5201-8-1: 1998

IEC60115-1: 1999, IEC60115-8: 1989 Amendment 1: 1992, IEC60115-8-1: 1989

EIAJ RC-2134B-2002

## 2. Classification

Type designation shall be the following form.

(Example)

RGC	1/8	C	123	D	TP
1	2	3	4	5	6
Style					

1 Fixed thick film chip resistors; rectangular type & precision

— Style

2 Rated dissipation and / or dimension

3 Temperature coefficient of resistance

K	±100×10 <sup>6</sup> / °C
С	±50×10 <sup>6</sup> / °C

- 4 Rated resistance Example;  $123 \rightarrow 12k\Omega$
- 5 Tolerance on rated resistance
- 6 Packaging form

#### 3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1

Table-1								
Ct do	Rated	Temperature coefficient of		Rated resistance	Preferred number	Tolerance on		
Style	dissipation (W)	resistance	e ( 10⁴ / °C)	$range(\Omega)$	series for resistors	rated resistance		
RGC1/32	0.03	С	± 50	100~100k	E24,96	D(±0.5%)		
RGC1/20	0.05	С	± 50	1k~1M	E04.00	D(10 E0/)		
KGC 1/20	0.05	K	±100	100~976	E24,96	D(±0.5%)		
		С	± 50	100~1M		D(±0.5%) F(±1%)		
RGC1/16S	0.063	0.063 K	±100	1.02M~3.3M	E24,96			
				10~97.6				
	0.1	С	± 50	100~1M	E24,96	D(±0.5%) F(±1%)		
DCC1/16			±100	1.02M~3.3M				
RGC1/16		K K		10~97.6				
				3.3~9.76		F(±1%)		
RGC1/10				50 10~3.3M	E24,96	D(±0.5%)		
	0.125	0.125 C	± 50			F(±1%)		
				3.3~9.76		F(±1%)		
				10~4.7M		D(±0.5%)		
RGC1/8	0.25	0.25 C	± 50	10~4.7101	E24,96	F(±1%)		
						3.3~9.76		F(±1%)

Style	Limiting element voltage (V)	Isolation voltage (V)	Category temperature range(°C)
RGC1/32	15	50	<i>–</i> 55∼+125
RGC1/20	25	50	-55~+125
RGC1/16S	50		<i>–</i> 55∼+155
RGC1/16	50	100	
RGC1/10	150	100	<i>–</i> 55∼+125
RGC1/8	200		

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#### 3.2 Climatic category

#### 3.2.1 RGC1/32,1/20,1/16,1/10,1/8

55/125/56 Lower category temperature – 55 °C

Upper category temperature +125 °C

Duration of the damp heat, steady state test 56days

3.2.2 RGC1/16S

55/155/56 Lower category temperature – 55 °C

Upper category temperature +155 °C

Duration of the damp heat, steady state test 56days

## 3.3 Stability class

5% Limits for change of resistance:

- for long - term tests  $\pm$  (5%+0.1Ω) - for short - term tests  $\pm$  (1%+0.05Ω)

#### 3.4 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

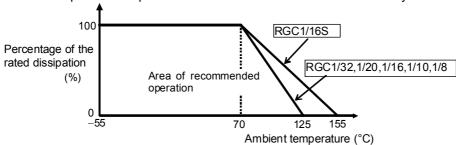


Figure-1 Derating curve

#### 3.5 Rated voltage

d.c.or a.c.r.m.s.voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

E: Rated voltage (V)

P: Rated dissipation (W)

R: Rated resistance 
$$(\Omega)$$

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

#### 4. Packaging form

The standard packaging form shall be in accordance with Table-2.

## Table-2

Symbol	Pack	kaging form	Standard packaging quantity / units	Application		
В	Bulk (loose package)		1,000 pcs.	RGC1/32,1/20,1/16S,1/16,1/10,1/8		
			5,000 pcs.	RGC1/8		
BA	A Bulk case		10,000 pcs.	RGC1/10		
			25,000 pcs.	RGC1/16		
PA	Press pocket taping	8mm width, 2mm pitches	20,000 pcs.	RGC1/32		
FA	(paper taping)		15,000 pcs.	RGC1/20		
TH	Paper taping	8mm width, 2mm pitches	10,000 pcs.	RGC1/16S		
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RGC1/16, 1/10, 1/8		

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#### 5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.

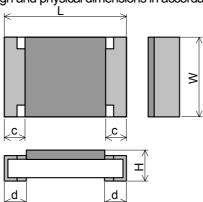


Figure-2

Table–3 Unit: mm

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Style	L	W	Н	С	d
RGC1/32	0.4±0.02	0.2±0.02	0.13±0.02	0.08±0.03	0.1±0.03
RGC1/20	0.6±0.03	0.3±0.03	0.23±0.03	0.1±0.05	0.15±0.05
RGC1/16S	1.0±0.05	0.5±0.05	0.35±0.05	0.2±0.1	$0.25^{+0.05}_{-0.10}$
RGC1/16	1.6±0.1	0.8 +0.15 -0.05	0.45±0.10	0.25±0.10	0.3±0.1
RGC1/10	2.0±0.1	1.25±0.10	0.6±0.1	0.4±0.2	0.4±0.2
RGC1/8	3.2±0.15	1.6±0.15	0.6±0.1	0.5±0.25	0.5±0.25

## 5.2 Net weight (Reference)

Style	Net weight(mg)
RGC1/32	0.035
RGC1/20	0.16
RGC1/16S	0.6
RGC1/16	2
RGC1/10	5
RGC1/8	9

## 6. Marking

The Rated resistance shall be marked in 3 digits (E24) or 4 digits (E96) and marked on over coat side.

The Rated resistance of RGC1/16 should not be marked in 4 digits.

The Rated resistance of RGC1/32,1/20,1/16S should not be marked.

(Example) "123" 
$$\rightarrow$$
 12 ×10<sup>3</sup> [ $\Omega$ ]  $\rightarrow$  12 [ $k\Omega$ ]

"3R3" 
$$\rightarrow$$
 3.3 [ $\Omega$ ]

$$\text{``}5623\text{''} \rightarrow 562 \times 10^3\text{ } [\Omega] \rightarrow 562\text{ } [\text{k}\Omega]$$

" 12R7" 
$$\to$$
 12.7 [ $\Omega$ ]

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#### 7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1: 1998.

7.2 The performance shall be satisfied in Table-4.

Table 4(1)

No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements
		` ,	· ·
1	Visual examination	Sub-clause 4.4.1	As in 4.4.1
		Checked by visual examination.	The marking shall be legible, as
			checked by visual examination.
2	Dimension	Sub-clause 4.4.2	As specified in Table-3 of this
			specification.
	Resistance	Sub-clause 4.5	As in 4.5.2
			The resistance value shall
			correspond with the rated resistance
			taking into account the specified
	11.5		tolerance.
3	Voltage proof	Sub-clause 4.7	No breakdown or flash over
		Method: 4.6.1.4(See Figure–5)	
		Test voltage: Alternating voltage with a peak	
		value of 1.42 times the insulation voltage.	
		Duration: 60 s ± 5 s	D: 400
		Insulation resistance	R≥1GΩ
		Test voltage: Insulation voltage	
	0.11.139	Duration: 1 min.	A : 447.45
4	Solderability	Sub-clause 4.17	As in 4.17.4.5
		Without ageing	The terminations shall be covered
		Flux: The resistors shall be immersed in a	with a smooth and bright solder coating.
		non–activated soldering flux for 2s.	coaung.
		Bath temperature: 235 °C ± 5 °C	
_	NA	Immersion time: 2 s ± 0.5 s	
5	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Overload	Test substrate: Figure–3	
	(in the mounted state)	Sub-clause 4.13	
	(in the modified state)	The applied voltage shall be 2.5 times the	
		rated voltage or twice the limiting element	
		voltage, whichever is the less severe.	
		Duration: 2 s	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
	Solvent resistance of the	Sub-clause 4.30	Legible marking
	marking	Solvent: 2–propanol	Logisio manting
		Solvent temperature: 23 °C ± 5 °C Method 1	
		Rubbing material: cotton wool	
L		Without recovery	

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## Table-4(2)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
6	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
		Test substrate: Figure-4	
	Bound strength of the end	Sub-clause 4.33	
	face plating	Bent value: 3 mm	
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
	Final measurements	Sub-clause 4.33.6	
		Visual examination	No visible damage
7	Resistance to soldering heat	Sub-clause 4.18	
	_	Solder temperature: 260 °C ± 5 °C	
		Immersion time: 10 s ± 0.5 s	
		Visual examination	As in 4.18.3.4
			No sign of damage such as cracks.
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
	Component solvent	Sub-clause 4.29	,
	resistance	Solvent: 2-propanol	
		Solvent temperature: 23 °C ± 5 °C	
		Method 2	
		Recovery: 48 h	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
8	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
		Test substrate: Figure–3	
	Adhesion	Sub-clause 4.32	
		Force: 5 N(RGC1/32: 2N, RGC1/20: 3N)	
		Duration: 10 s ± 1 s	
		Visual examination	No visible damage
	Rapid change temperature	Sub-clause 4.19	
		RGC1/32,1/20,1/16,1/10,1/8	
		Lower category temperature: -55 °C	
		Upper category temperature: +125 °C	
		RGC1/16S	
		Lower category temperature: -55 °C	
		Upper category temperature: +155 °C	
		Duration of exposure at each temperature: 30	
		min.	
		Number of cycles: 5 cycles.	No visible damage
		Visual examination	No visible darriage $\Delta R \le \pm (1\% + 0.05\Omega)$
L		Resistance	$\Delta \Gamma \geq I(170TU.UUS2)$

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## Table-4(3)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
9	Climatic sequence	Sub-clause 4.23	
	-Dry heat	Sub-clause 4.23.2	
		RGC1/32,1/20,1/16,1/10,1/8	
		Test temperature: +125 °C	
		RGC1/16S:	
		Test temperature: +155 °C	
		Duration: 16 h	
	–Damp heat, cycle	Sub-clause 4.23.3	
	(12+12hour cycle)	Test method: 2	
	First cycle	Test temperature: 55 °C	
		[Severity(2)]	
	-Cold	Sub-clause 4.23.4	
		Test temperature –55 °C	
		Duration: 2h	
	–Damp heat, cycle	Sub-clause 4.23.6	
	(12+12hour cycle)	Test method: 2	
	Remaining cycle	Test temperature: 55 °C	
		[Severity (2)]	
		Number of cycles: 5 cycles	
	–D.C. load	Sub-clause 4.23.7	
		The applied voltage shall be the rated voltage	
		or the limiting element voltage whichever is the	
		smaller.	
		Duration: 1 min.	No visible damage
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (5\% + 0.1\Omega)$
10	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
		Test substrate: Figure–3	
	Endurance at 70 °C	Sub-clause 4.25.1	
		Ambient temperature: 70 °C ± 2 °C	
		Duration: 1000 h	
		The voltage shall be applied in cycles of 1.5 h	
		on and 0.5 h.	
		The applied voltage shall be the rated voltage	
		or the limiting element voltage whichever is the	
		smaller.	
		Examination at 48 h, 500 h and	
		1000 h:	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (5\% + 0.1\Omega)$

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## Table-4(4)

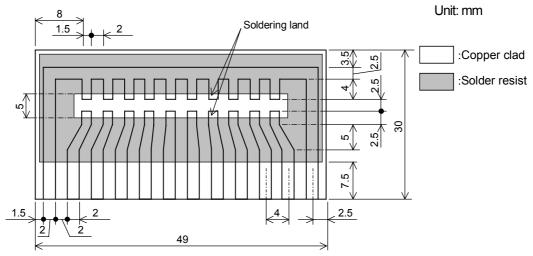
No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
11	Mounting  Variation of resistance with temperature	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub-clause 4.8 RGC1/32,1/20,1/16,1/10,1/8: +20 °C / +125°C RGC1/16S: +20 °C / +155°C	As in Table–1
12	Mounting  Damp heat, steady state	Sub-clause 4.31 Substrate material: Epoxide woven glass Test substrate: Figure–3 Sub-clause 4.24 Ambient temperature: 40 °C ± 2 °C Relative humidity: 93+3/2 % a) 1st group: without voltage applied. b) 2nd group: The d.c.voltage shall be applied continuously. The voltage shall be accordance with Sub-clause 4.24.2.1 b). without polarizing voltage [4.24.2.1, c)] Visual examination Resistance	No visible damage Legible marking ΔR ≤ ± (5%+0.1Ω)
13	Dimensions (detail)  Mounting  Endurance at upper category temperature	Sub-clause 4.4.3  Sub-clause 4.31  Substrate material: Epoxide woven glass Test substrate: Figure–3  Sub-clause 4.25.3  RGC1/32,1/20,1/16,1/10,1/8:  Ambient temperature:125 °C ± 2 °C  RGC1/16S:  Ambient temperature:155 °C ± 2 °C  Duration: 1000 h  Examination at 48 h, 500 h and 1000 h:  Visual examination Resistance	As in Table–3  No visible damage $\Delta R \le \pm (5\%+0.1\Omega)$

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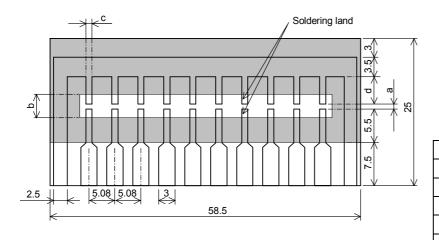
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#### 8. Test substrate



**RGC1/8 TEST SUBSTRATE** 



Unit: ı	mm
	]:Copper clad
	:Solder resis

Style	а	b	С	d
RGC1/32	0.2	0.56	0.2	5.3
RGC1/20	0.3	1.5	0.45	5.2
RGC1/16S	0.6	1.9	0.7	4.9
RGC1/16	1.0	3.6	1.0	4.5
RGC1/10	1.2	4.0	1.5	4.3

RGC1/32,1/20,1/16S,1/16,1/10 TEST SUBSTRATE

Figure-3

Remark 1). Material: Epoxide woven glass

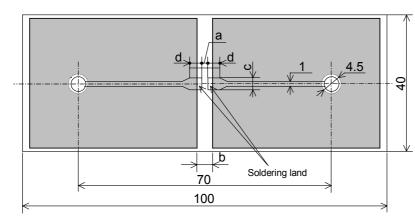
Thickness: 1.6mm Thickness of copper clad: 0.035mm

2). In the case of connection by connector, the connecting terminals are gold plated. However, the plating is not necessary when the connection is made by soldering.

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Unit	mm
	:Copper clad
	:Solder resist

Style	а	b	С	d
RGC1/20	0.3	1.1	0.45	2.15
RGC1/16S	0.6	1.9	0.7	2.0
RGC1/16	1.0	3.6	1.2	3.0
RGC1/10	1.2	4.0	1.65	3.0
RGC1/8	2.5	5.0	2.0	2.5

## RGC BOUND STRENGTH OF THE END FACE PLATING TEST SUBSTRATE

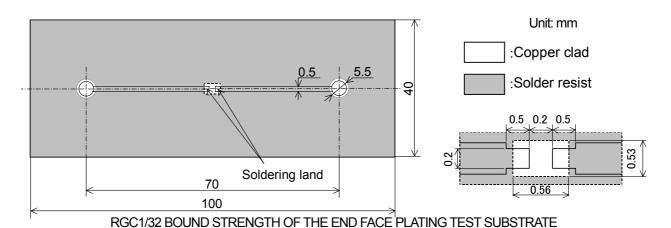
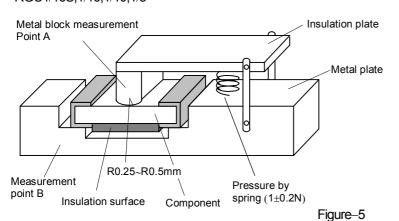


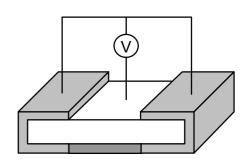
Figure-4

Remark 1). Material: Epoxide woven glass
Thickness: 1.6mm Thickness of copper clad: 0.035mm

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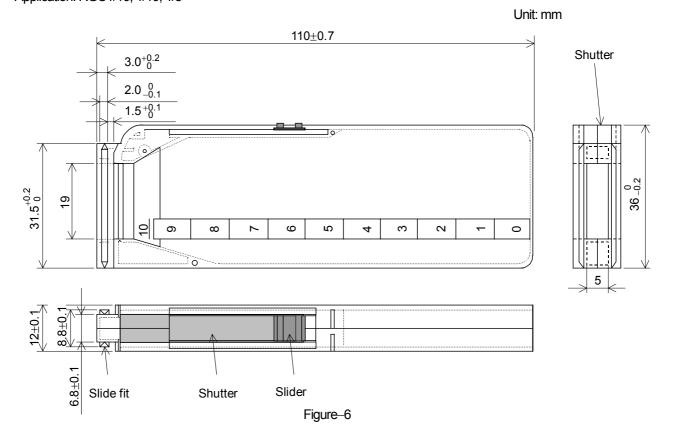
Drawing No: RGC-K-HTS-0001 /10

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## 9. Design and dimensions of bulk case

- 9.1 Applicable documents JIS C 0806-6:2006
- 9.2 The bulk case shall be of the design and physical dimensions in accordance with Figure–6. Application: RGC1/16, 1/10, 1/8



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#### 10. Taping

10.1 Applicable documents JIS C 0806-3: 1999, EIAJ ET-7103: 2004, EIAJ ET-7200B: 2003

#### 10.2 Taping dimensions

10.2.1 Press pocket taping (Paper taping, 8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-7 and Table-5.

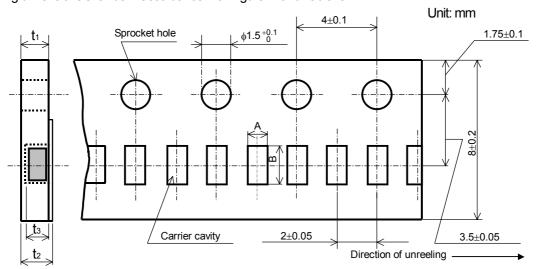
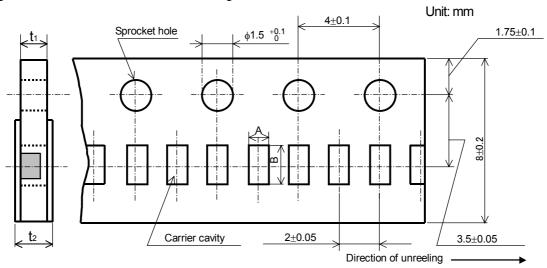


Figure-7 Table-5 Unit: mm В Style t<sub>1</sub> RGC1/32 0.24±0.03 0.45±0.03 0.31±0.03 0.36±0.02 0.15±0.02 RGC1/20 0.37±0.05 0.67±0.05 0.42±0.03 0.45±0.05 0.27±0.02

## 10.2.2 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-8 and Table-6.



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#### 10.2.3 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-9 and Table-7.

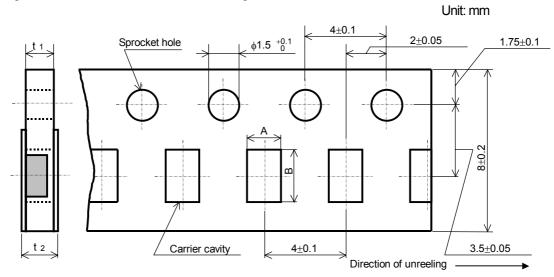
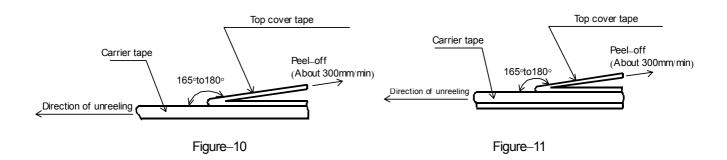


Figure-9

	Table-7				Unit: mm	
	Style	Α	В	<b>t</b> 1	<b>t</b> 2	
Ī	RGC1/16	1.15 ± 0.15	1.9 ± 0.2	$0.6 \pm 0.1$	0.8max.	
Ī	RGC1/10	1.65 ± 0.15	$2.5 \pm 0.2$	0.8 ± 0.1	1.0max.	
	RGC1/8	$2.00 \pm 0.15$	$3.6 \pm 0.2$			

- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RGC1/32,1/20: Figure-10, RGC1/16S, 1/16, 1/10, 1/8: Figure-11.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.

  The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.

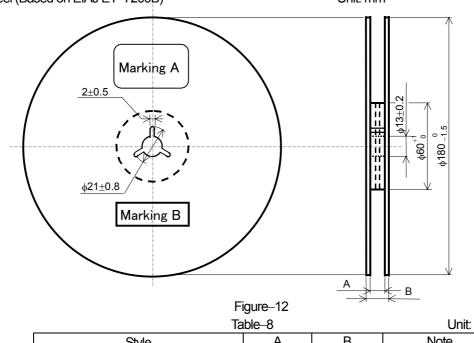


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#### 10.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–12 and Table–8. Plastic reel (Based on EIAJ ET–7200B)

Unit: mm



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

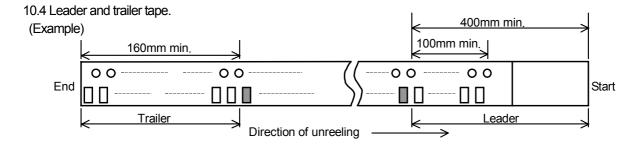


Figure-13

## 10. Marking on package

The label of a minimum package shall be legibly marked with follows.

## 10.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others

10.2 Marking B (KAMAYA control label)